

# **Small-Signal Switching Diodes**



#### **Features**

- V<sub>R</sub> 80V
- I<sub>FAV</sub> 150mA

## **Typical Applications**

• Extreme fast switches

### **Mechanical Data**

• Package: SOD323

• Terminals: Tin plated leads, solderable per

J-STD-002 and JESD22-B102

• Polarity: Cathode line denotes the cathode end

●Marking: A

## ■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Conditions	VALUE
Repetitive peak reverse voltage	$V_{RRM}$	V		90
Maximum DC Blocking	V <sub>DC</sub>	V		80
Peak forward surge current	I <sub>FSM</sub>	Α	t <sub>p</sub> =1µs	2
Average forward current	I <sub>FAV</sub>	mA		150
Power dissipation	P <sub>tot</sub>	mW		200
Maximum junction temperature	T <sub>j</sub>	$^{\circ}$ C		-65 to +150
Storage temperature range	T <sub>stg</sub>	$^{\circ}$		-65 to +150

## **■**Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Conditions	VALUE
Maximum Forward voltage	V <sub>F</sub>	mV	I <sub>F</sub> =100mA	1200
Maximum Reverse current	I <sub>R</sub>	nA	V <sub>R</sub> =80V	100
Minimum Breakdown voltage	$V_R$	V	I <sub>R</sub> =1μA	80
Maximum Diode capacitance	C <sub>D</sub>	pF	V <sub>R</sub> =6.0V, f =1MH <sub>Z</sub>	3.0
Maximum Reverse recovery time	t <sub>rr</sub>	ns	I <sub>F</sub> =10mA,V <sub>R</sub> =6V	4

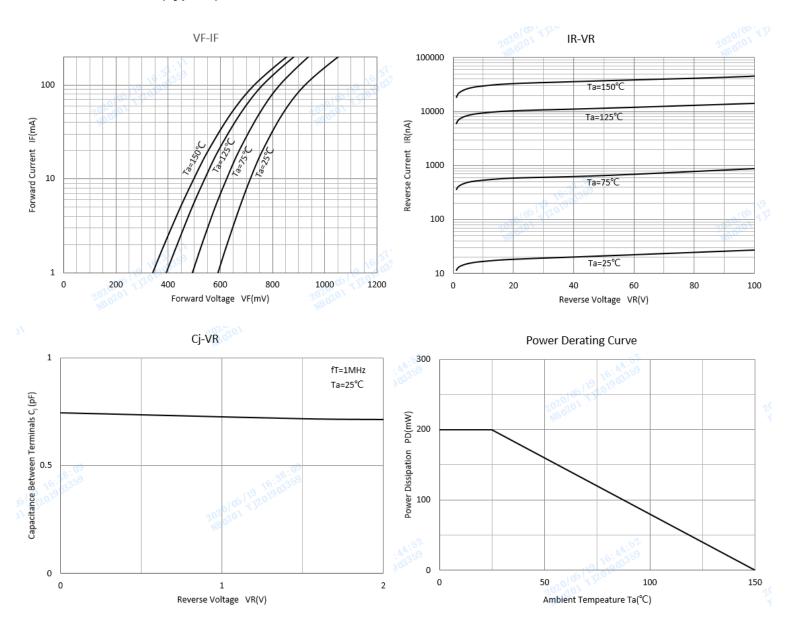


## **1SS355**

**■**Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
1SS355	F2	Approximate 0.0048	3000	30000	120000	7" reel

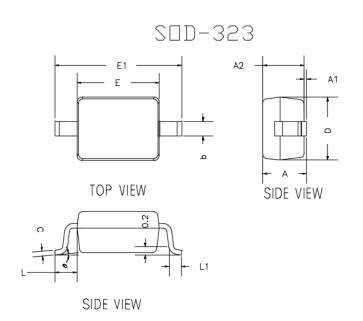
## ■ Characteristics (Typical)





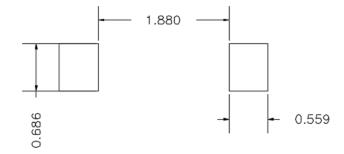
## **1SS355**

## **■**Outline Dimensions



DIMENSIONS					
DIM	INC	HES	ММ		
	MIN	MAX	MN	MAX	
А		0.0393		1.0000	
A1	0.0000	0.0039	0.0000	0.1000	
A2	0.0314	0.0354	0.8000	0.9000	
lo	0.0098	0.0157	0.2500	0.4000	
С	0.0031	0.0059	0.0800	0.1500	
D	0.0472	0.0551	1.2000	1,4000	
E	0.0629	0.0709	1.6000	1.8000	
E1	0.0984	0.1063	2.5000	2.7000	
L	0.018	7TYP	0.475TYP		
L1	0.0098	0.0157	0.250	0.400	
Θ	0°	8*	0°	8*	

## **■**Soldering Footprint



UNIT: mm

SUGGESTED SOLDER PAD LAYOUT



## **1SS355**

#### **Disclaimer**

The information presented in this document is for reference only. Shanghai Sunco Electronics Co., Ltd reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Russiansunco or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website http:// <a href="http://www.russiansunco.com">www.russiansunco.com</a>, or consult your nearest Russiansunco's sales office for further assistance.